

S1A - S1M

Features

- · Low profile package.
- · Glass passivated junction.



General Purpose Rectifiers

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	Value					Units		
		1A	1B	1D	1G	1J	1K	1M	
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
I _{F(AV)}	Average Rectified Forward Current, @ T _A = 100°C	1.0			Α				
I _{FSM}	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave 40			Α					
T _{stg}	Storage Temperature Range		-55 to +150						°C
T _J	Operating Junction Temperature -55			5 to +1	50			°C	

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_{D}	Power Dissipation	1.4	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient*	85	°C/W

^{*}Device mounted on FR-4 PCB 0.013 mm.

Electrical Characteristics $T_A = 25$ °C unless otherwise noted

Symbol	Parameter		Device						
		1A	1B	1D	1G	1J	1K	1M	
V _F	Forward Voltage @ 1.0 A				1.1				V
t _{rr}	Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	1.8			μs				
I _R	Reverse Current @ rated V_R $T_A = 25^{\circ}C$ $T_A = 125^{\circ}C$				1.0 50				μ Α μ Α
С _т	Total Capacitance V _R = 4.0 V, f = 1.0 MHz				12				pF

General Purpose Rectifiers

(continued)

Typical Characteristics

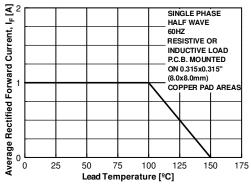
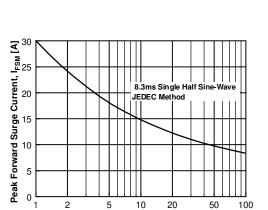


Figure 1. Forward Current Derating Curve



Number of Cycles at 60Hz
Figure 3. Non-Repetitive Surge Current

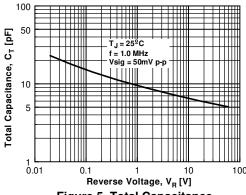


Figure 5. Total Capacitance

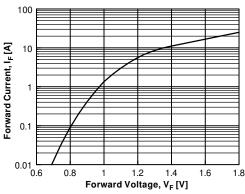


Figure 2. Forward Voltage Characteristics

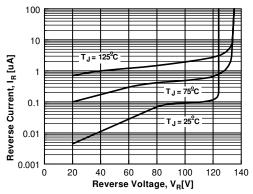


Figure 4. Reverse Current vs Reverse Voltage

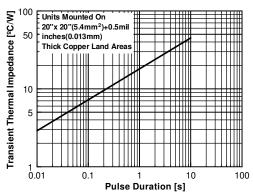


Figure 6. Thermal Impedance Characteristics

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